

INTERNATIONAL STANDARD



Printed electronics –
Part 201: Materials – Substrates

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

PRINTED ELECTRONICS –

Part 201: Materials – Substrates

FOREWORD

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IEC 62899-201 edition 1.1 contains the first edition (2016-02) [documents 119/87/FDIS and 119/100A/RVD] and its amendment 1 (2018-11) [documents 119/189/CDV and 119/206A/RVC].

In this Redline version, a vertical line in the margin shows where the technical content is modified by amendment 1. Additions are in green text, deletions are in strikethrough red text. A separate Final version with all changes accepted is available in this publication.

International Standard IEC 62899-201 has been prepared by IEC technical committee 119: Printed electronics.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 62899 series, published under the general title *Printed electronics*, can be found on the IEC website.

The committee has decided that the contents of the base publication and its amendment will remain unchanged until the stability date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

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INTRODUCTION

The IEC 62899-20x series relates mainly to evaluation methods for materials of printed electronics. The series also includes storage methods, packaging and marking, and transportation conditions.

The IEC 62899-20x series is divided into parts for each material. Each part is prepared as a generic specification containing fundamental information for the area of printed electronics.

The IEC 62899-20x series consists of the following parts:

Part 201: Materials – Substrates

Part 202: Materials – Conductive ink

Part 203: Materials – Semiconductor ink¹

(Subsequent parts will be prepared for other materials.)

Furthermore, sectional specifications, blank detail specifications, and detail specifications for each material will follow these parts.

This part of IEC 62899 is prepared for substrate used in printed electronics and contains the test conditions, the evaluation methods and the storage conditions.

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¹ Under consideration.

PRINTED ELECTRONICS –

Part 201: Materials – Substrates

1 Scope

This part of IEC 62899 defines the terms and specifies the evaluation method for substrates used in the printing process to form electronic components/devices. This international standard is also applied to the substrates which make surface treatment in order to improve their performance.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60050 (all parts), *International Electrotechnical Vocabulary* (available at www.electropedia.org)

IEC 60093:1980, *Methods of test for volume resistivity and surface resistivity of solid electrical insulating materials*

IEC 60216-1:2013, *Electrical insulating materials – Thermal endurance properties – Part 1: Ageing procedures and evaluation of test results*

IEC 60216-2, *Electrical insulating materials – Thermal endurance properties – Part 2: Determination of thermal endurance properties of electrical insulating materials – Choice of test criteria*

IEC 60216-3, *Electrical insulating materials – Thermal endurance properties – Part 3: Instructions for calculating thermal endurance characteristics*

IEC 60216-4-1, *Electrical insulating materials – Thermal endurance properties – Part 4-1: Ageing ovens – Single-chamber ovens*

IEC 60216-5, *Electrical insulating materials – Thermal endurance properties – Part 5: Determination of relative thermal endurance index (RTE) of an insulating material*

IEC 60216-6, *Electrical insulating materials – Thermal endurance properties – Part 6: Determination of thermal endurance indices (TI and RTE) of an insulating material using the fixed time frame method*

IEC 60243-1:2013, *Electric strength of insulating materials – Test methods – Part 1: Tests at power frequencies*

IEC 60674-2:1988, *Specification for plastic films for electrical purposes – Part 2: Methods of test*

IEC 60674-2:1988/AMD1:2001

IEC 60674-3-1:1998, *Plastic films for electrical purposes – Part 3: Specifications for individual materials – Sheet 1: Biaxially oriented polypropylene (PP) films for capacitors*
IEC 60674-3-1/AMD1:2011

IEC 60695-11-10, *Fire hazard testing – Part 11-10: Test flames – 50W horizontal and vertical flame test methods*

IEC 60721-3-1, *Classification of environmental conditions – Part 3 Classification of groups of environmental parameters and their severities – Section 1: Storage*

IEC 60721-3-2, *Classification of environmental conditions – Part 3: Classification of groups of environmental parameters and their severities – Section 2: Transportation*

IEC 61189-2:2006, *Test methods for electrical materials, printed boards and other interconnection structures and assemblies – Part 2: Test methods for materials for interconnection structures*

IEC 61189-3:2007, *Test methods for electrical materials, printed boards and other interconnection structures and assemblies – Part 3: Test methods for interconnection structures (printed boards)*

IEC 62321-3-1, *Determination of certain substances in electrotechnical products – Part 3-1: Screening – Lead, mercury, cadmium, total chromium and total bromine using X-ray fluorescence spectrometry*

IEC 62899-202-5, *Printed electronics – Part 202-5: Materials – Conductive ink – Mechanical bending test of a printed conductive layer on an insulating substrate*

ISO 5-2, *Photography and graphic technology – Density measurements – Part 2: Geometric conditions for transmittance density*

ISO 5-3, *Photography and graphic technology – Density measurements – Part 3: Spectral conditions*

ISO 62, *Plastics – Determination of water absorption*

ISO 175:2010, *Plastics – Methods of test for the determination of the effects of immersion in liquid chemicals*

ISO 187, *Paper, board and pulps – Standard atmosphere for conditioning and testing and procedure for monitoring the atmosphere and conditioning of samples*

ISO 216, *Writing paper and certain classes of printed matter – Trimmed sizes – A and B series, and indication of machine direction*

ISO 217, *Paper – Untrimmed sizes – Designation and tolerances for primary and supplementary ranges, and indication of machine direction*

ISO 291, *Plastics – Standard atmospheres for conditioning and testing*

ISO 472, *Plastics – Vocabulary*

ISO 489:1999, *Plastics – Determination of refractive index*

ISO 527-1:2012, *Plastics – Determination of tensile properties – Part 1: General principles*